PART NUMBER:

KXM52-8100

Rev. -Mar 07

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ECN #	REV	PG #	REVISION DESCRIPTI	ON	DATE		REV'D BY
	-		Initial Release		3/30/07	K. Foust	

PART NUMBER:

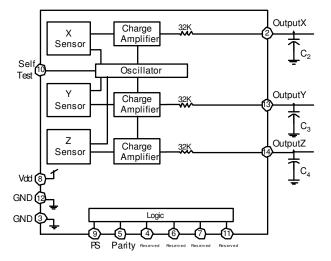
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Product Description

The KXM52-8100 is a three axis, analog output silicon micromachined accelerometer with a fullscale output range of ± 1.0 g (9.8 m/s²) in the x and y directions, ± 1.5 g (14.7 m/s²) in the z direction. Plasma micromachining is used to fabricate the sense element using Kionix's proprietary deep reactive ion etch processes. Kionix linear accelerometers function on the principle of differential capacitance; acceleration causes displacement of a silicon structure resulting in a capacitance change. Common mode cancellation is used to decrease errors from process variation, temperature, and environmental stress. The sense element is hermetically sealed at the wafer level by bonding a silicon lid wafer to the device using glass frit. A separate ASIC device packaged with the sense element provides signal conditioning and self-test. The accelerometer is delivered in a 5 x 5 x 1.8 mm Dual Flat No-lead (DFN) package.

Functional Diagram



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Product Specifications

Table 1. Mechanical

(specifications are for operation at $V_{dd} = 3.3V$ and T = 25^oC unless stated otherwise)

Parameters	Units	Min	Target	Max
Operating Temperature Range	°C	-40	-	85
Zero-g Offset	V	1.600	1.650	1.700
Zero-g Offset Variation from RT over Temp.	mg	-150	-	150
Sensitivity	mV/g (xy) mV/g (z)	1280 854	1320 880	1360 906
Sensitivity Variation from RT over Temp.	%	-2	0	+2
Offset Ratiometric Error ($V_{dd} = 3.3V \pm 5\%$)	%	-	0.4	1.5
Sensitivity Ratiometric Error ($V_{dd} = 3.3V \pm 5\%$)	%	-	0.4	1.5
Non-Linearity	% of FS	-	0.1	0.5
Cross Axis Sensitivity	%	-	2.0	3.0
Self Test Output change on Activation	g	0.5 (xy) 0.1 (z)	0.6 (xy) 0.2 (z)	0.7 (xy) 0.3 (z)
Bandwidth (-3dB) ¹	Hz	-	-	3100 (XY) 1300 (Z)
Noise Density (on filter pins)	µg / √Hz	-	35 (xy) 65 (z)	100

Notes:

1. User definable with external capacitors. Maximum defined by the frequency response of the sensors.

Table 2. Electrical

(specifications are for operation at V_{dd} = 3.3V and T = 25^oC unless stated otherwise)

Parameters	Units	Min	Target	Мах	
Supply Voltage (V _{dd})	Operating	V	2.5	3.3	5.5
Current Consumption	Operating ¹	mA	1.3	1.7	2.3
Current Consumption	Standby	μA	-	-	10
Analog Output Resistance(Rout)		kΩ	24	32	40
Power Up Time ¹		ms		5*R _{out} *C	

Notes:

1. Power up time is determined by 5 times the RC time constant of the user defined low pass filter.

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Table 3. Environmental

Parameters	Units	Min	Target	Max	
Supply Voltage (V _{dd})	Absolute Limits	V	-0.3	-	7.0
Operating Temperatur	°C	-40	-	85	
Storage Temperature	°C	-55	-	150	
Mech. Shock (powered and unpowered)		g	-	-	4600 for 0.5ms
ESD	HBM	V	-	-	3000



Caution: ESD Sensitive and Mechanical Shock Sensitive Component, improper handling can cause permanent damage to the device.

The 14-pin DFN package conforms to European Union Directive 2002/95/EC on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS).

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Application Schematic and Pin Function Table

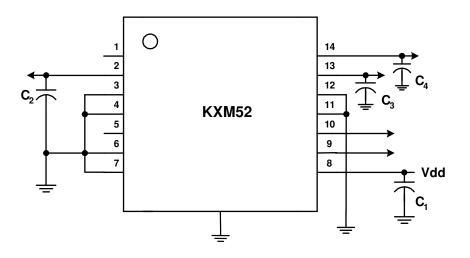


Table 4. KXM52 Pin Descriptions

Pin	Name	Description			
1	NC	Not Connected Internally.			
2	X Output	Analog output of the x-channel. Optionally, a capacitor (C ₂) placed between this pin and ground will form a low pass filter.			
3	GND	Ground			
4	Reserved	Factory reserved. Connect this pin to ground.			
5	Parity	Checks EEPROM for parity error. Float if not used.			
6	Reserved	Factory reserved. Connect this pin to ground.			
7	Reserved	Factory reserved. Connect this pin to ground.			
8	Vdd	The power supply input. Decouple this pin to ground with a 0.1 uF ceramic capacitor (C ₁).			
9	PS	Power shutdown: Low – Normal operation; High – Device is in self-test mode.			
10	ST	Self Test. Low - Normal operation; High – Device is in self-test mode.			
11	Reserved	Factory reserved. Connect this pin to ground.			
12	GND	Ground			
13	Y Output	Analog output of y-channel. Optionally, a capacitor (C ₃) placed between this pin and ground will form a low pass filter.			
14	DNC	Do Not Connect			
	Center Pad	Ground			

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Application Design Equations

The bandwidth is determined by the filter capacitors connected from pins 2, 13 and 14 to ground. The response is single pole. Given a desired bandwidth, f_{BW} , the filter capacitors are determined by:

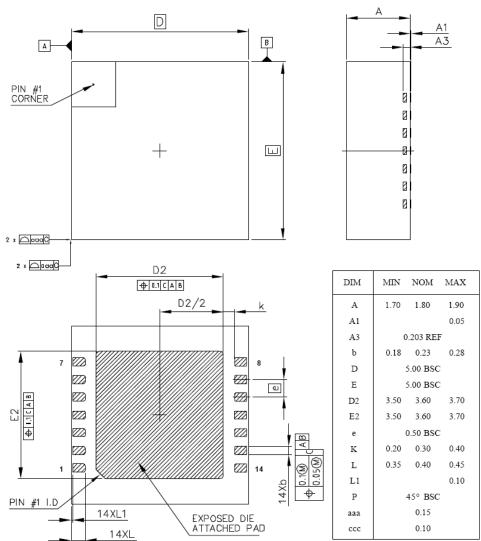
$$C_2 = C_3 = C_4 = \frac{4.97 \, x 10^{-6}}{f_{BW}}$$

Special Characteristics:

These characteristics have been identified as being critical to the customer. Every part is tested to verify its conformance to specification prior to shipment.

Parameters	Specification	Test Conditions	
Zero-g Offset @ RT	1.650 ± 0.200 V	25ºC, V _{dd} = 3.3V	
Sensitivity @ RT	1320 ± 30 mV/g 880 ± 20 mV/g	$25^{\circ}C, V_{dd} = 3.3V$	
Cross Axis Sensitivity	< 3%	25ºC, V _{dd} = 3.3V	
Current Consumption Operating	1.3 <= I _{dd} <= 2.0 mA	25ºC, V _{dd} = 3.3V	

Package Dimensions



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NOTES

- 1.0 DIMENSIONING & TOLERANCEING CONFIRM TO ASME Y14.5M-1994.
- 2.0 ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
- 3.0 DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25mm AND 0.30mm FROM TERMINAL TIP. DIMENSION L1 REPRESENTS TERMINAL FULL BACK FROM PACKAGE EDGE UP TO 0.1mm IS ACCEPTABLE.
- 4.0 COPLANARITY APPLIES TO THE EXPOSED HEAT SLUG AS WELL AS THE TERMINAL.
- 5.0 RADIUS ON TERMINAL IS OPTIONAL.

Package Orientation

